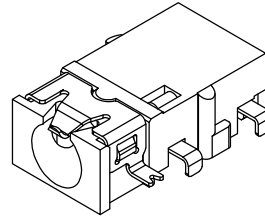
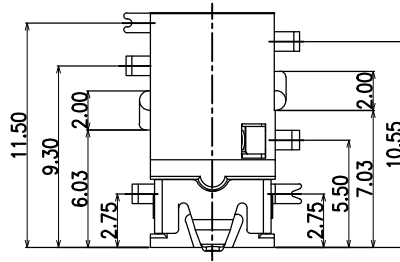
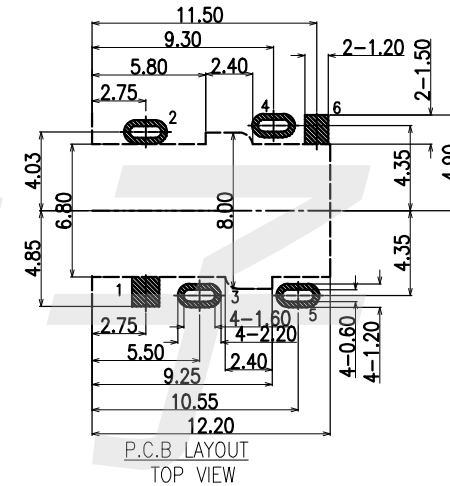
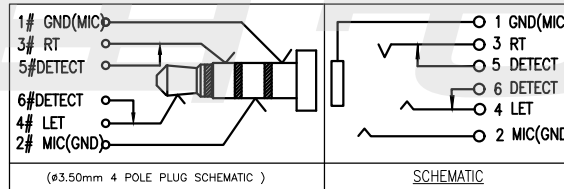
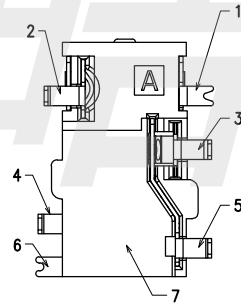
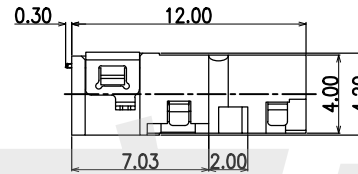
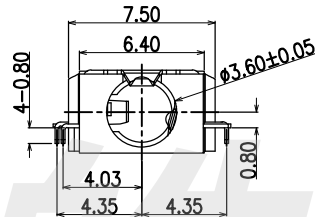


NOTES:

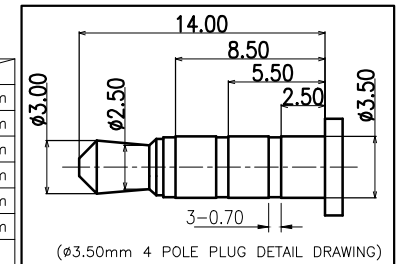
1. CONTACT CURRENT RATING: 1A.
2. CONTACT RESISTANCE: 50 mΩ MAX.;
3. INSULATION RESISTANCE: 100MΩ MIN.;
4. DIELECTRIC WITHSTANDING: 500V AC MIN.;
5. DURABILITY: 5,000 CYCLES MIN.;
6. CONNECTOR MATING FORCES: 30N MAX.;
7. CONNECTOR UNMATING FORCES: 3N MIN.;



3D VIEW

P.C.B. LAYOUT
TOP VIEW

⑦	HOUSING	1	HIGHT TEMPERATURE PLASTIC COLOR BLACK	
⑥	CONTACT 6#	1	STAINLESS STEEL; NICKEL UNDER PLATING OVERALL,GOLD FLASH ON SOLDER AREA	T=0.20mm
⑤	CONTACT 5#	1	STAINLESS STEEL; NICKEL UNDER PLATING OVERALL,GOLD FLASH ON SOLDER AREA	T=0.20mm
④	CONTACT 4#	1	COPPER ALLOY; NICKEL UNDER PLATING OVERALL,GOLD FLASH PLATING ON SOLDER AREA ,GOLD FLASH PLATING ON CONTACT AREA	T=0.20mm
③	CONTACT 3#	1	STAINLESS STEEL; NICKEL UNDER PLATING OVERALL,GOLD FLASH ON SOLDER AREA	T=0.20mm
②	CONTACT 2#	1	COPPER ALLOY; NICKEL UNDER PLATING OVERALL,GOLD FLASH PLATING ON SOLDER AREA ,GOLD FLASH PLATING ON CONTACT AREA	T=0.20mm
①	CONTACT 1#	1	STAINLESS STEEL; NICKEL UNDER PLATING OVERALL,GOLD FLASH ON OVERALL;	T=0.20mm
ITEM	PART NAME	Q'TY	MATERIAL	REMARK



HAOFU ELECTRONCS TECHNOLOGY CO.,LTD

PART NAME

PHONE JACK

DRAWING

Y,C,ZHANG

DWG.No.

SBICL

PART NO.

PJ-399G

CHECK

G.C.Chen

REV.

A1

UNIT :
mmTOLERANCE
OTHERWISEUP TO 5
ABOVE 5 ~30
ABOVE 30
ANGLE±0.2
±0.3
±0.5
±3°

APPROVAL

SCALE

2:1

DATE

PAGE

1 OF 1

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